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FORM PTO-1595

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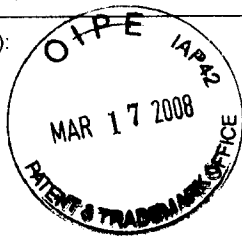
To the Honorable Director of Patents and Trademarks

ments or copy thereof.

103490883

1. Name of Conveying party(ies):

Hidchiko OKUDA
Tatsumi KUSABA
Akihiko ENDO



2. Name and address of receiving party(ies)

Name: SUMCO CORPORATION

Internal Address: _____

Street Address: 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 Japan

City: _____ State: _____ ZIP: _____

Additional names(s) and address(es) attached? Yes No

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: March 3, 2008

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

11/957,674

B. Patent No.(s)

Additional numbers attached: Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Bruce H. Bernstein

Internal Address: P33412

Street Address: GREENBLUM & BERNSTEIN, P.L.C.

1950 Roland Clarke Place

City: Reston State: VA ZIP: 20191

6. Total number of applications and patents involved: 1

7. Total Fee (37CFR 3.41) \$40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

19-0089

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Bruce H. Bernstein, Reg. No. 29,027

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and document: 4

Mail documents to be recorded with required cover sheet information to:
Director of the United States Patent and Trademark Office, Mail Stop Assignments Recordation Services
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Alexandria, VA 22314

40.00 00

ASSIGNMENT

WHEREAS, **Hidehiko OKUDA**, a citizen of Japan, whose post office address is c/o **SUMCO CORPORATION**, 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 JAPAN, **Tatsumi KUSABA**, a citizen of Japan, whose post office address is c/o **SUMCO CORPORATION**, 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 JAPAN, and **Akihiko ENDO**, a citizen of Japan, whose post office address is c/o **SUMCO CORPORATION**, 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 JAPAN, hereinafter referred to as the **ASSIGNORS**, have invented a certain improvement relating to

Method of manufacturing bonded wafer

for which they have jointly executed, on the same date as this assignment, an application for Letters Patent of the United States to be filed in the United States Patent and Trademark Office.

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the attorneys of record in this application including Neil F. Greenblum, Reg. No. 28,394, Bruce H. Bernstein, Reg. No. 29,027, Arnold Turk, Reg. No. 33,094, James L. Rowland, Reg. No. 32,674, Stephen M. Roylance, Reg. No. 31,296, Leslie J. Paperner, Reg. No. 33,329, William Pieprz, Reg. No. 33,630, Robert W. Mueller, Reg. No. 35,043, Andrew M. Calderon, Reg. No. 38,093, William E. Lyddane, Reg. No. 41,568 and William S. Boshnick, Reg. No. 44,550, of the firm Greenblum & Bernstein, P.L.C., whose address is 1950 Roland Clarke Place, Reston, Virginia 20191, to insert here in parenthesis (Application No. 11/957,674, filed 12/17/2007) the filing date and application number of said application when known.

AND WHEREAS, **SUMCO CORPORATION**, a corporation organized and existing under the laws of Japan, whose post-office address is 2-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8634 JAPAN, hereinafter known as the **ASSIGNEE**, is desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.

NOW, THIS WITNESSETH that for good and valuable consideration, the receipt whereof is hereby acknowledged, said **ASSIGNORS** hereby assign, sell and transfer to said **ASSIGNEE**, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights to sue for past and future infringement thereunder, said **ASSIGNEE** and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said **ASSIGNEE** and its assigns and legal representatives in as

ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS on the respective dates indicated below.

First Witness:

Hideki Nishihata
(Name) Hideki NISHIHATA

March 3, 2008
(Date)

Hidehiko Okuda March 3, 2008
Hidehiko OKUDA **Date**

Second Witness:

Daisuke Kikuchi
(Name) Daisuke KIKUCHI

March 3, 2008
(Date)

First Witness:

Hideki Nishihata
(Name) Hideki NISHIHATA

March 3, 2008
(Date)

Tatsumi Kusaba March 3, 2008
Tatsumi KUSABA Date

Second Witness:

Daisuke Kikuchi
(Name) Daisuke KIKUCHI

March 3, 2008
(Date)

First Witness:

Hideki Nishihata
(Name) Hideki NISHIHATA

March 3, 2008
(Date)

Akihiko Endo March 3, 2008
Akihiko ENDO Date

Second Witness:

Daisuke Kikuchi
(Name) Daisuke KIKUCHI

March 3, 2008
(Date)